

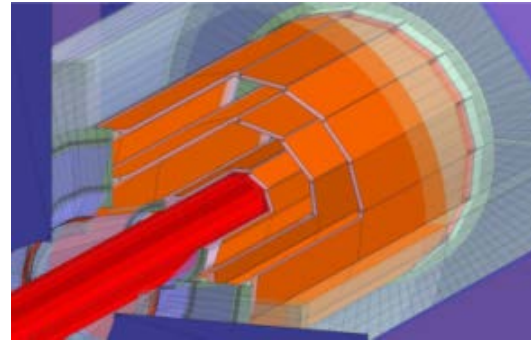
Summary of Mechanical Design of Silicon Vertex Detector Prototype

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Vertex Layout in Preliminary Design

	R (mm)	$ z $ (mm)	Current z in total
Layer 1	16	62.5	} 130.6 mm
Layer 2	18	62.5	
Layer 3	37	125.0	} 263.1 mm
Layer 4	39	125.0	
Layer 5	58	125.0	} 263.1 mm
Layer 6	60	125.0	



6 layer of sensors (3 layer barrels, each has sensors mounted double sides)

- * **Material budget:** 0.15% X/X_0 for each single sensor layer.
- * **Single point resolution:** currently in CDR range from 2.8-6 μm , eventually we aim for only one type of pixel sensor with single point resolution of 3-5 μm .
- * **Power dissipation:**
 - Final goal: $\leq 50 \text{ mW/cm}^2$. (air cooling)
 - Current (short term) goal: $\leq 200 \text{ mW/cm}^2$. (air cooling)
- * **Working temperature range:** 20-50 $^{\circ}\text{C}$ (30?)

Vertex detector (VTX) model

MOST2 project Goal: build a vertex detector prototype for CEPC

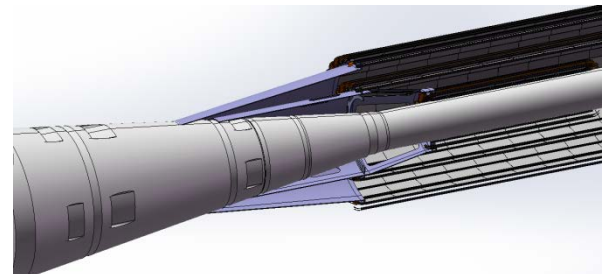
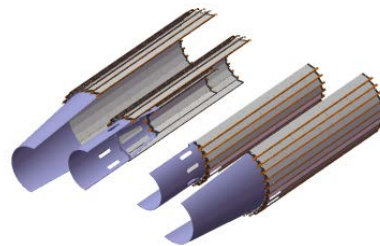
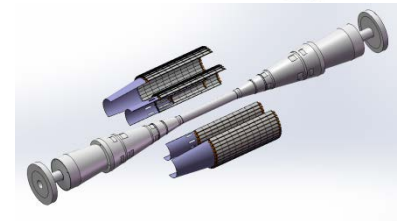
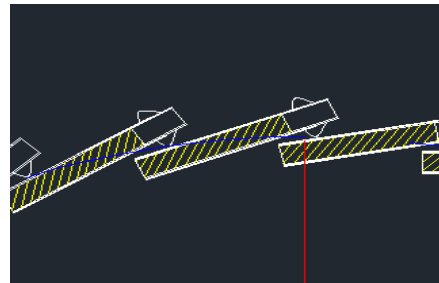
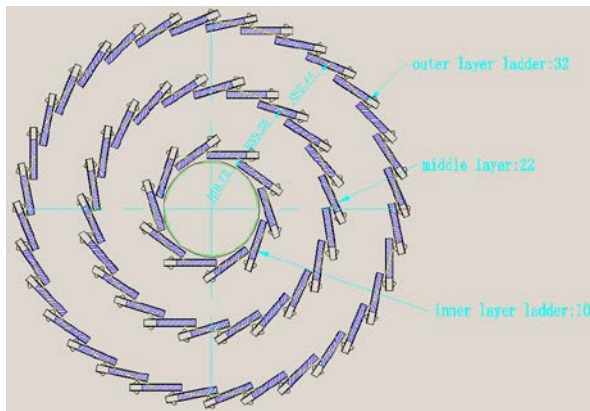
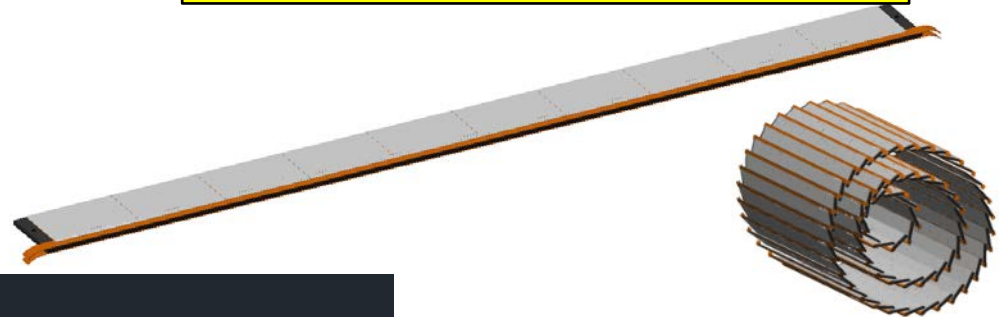
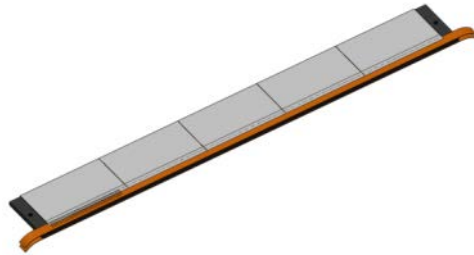
Sensor chip : 14.8 x 25.6 x 0.05 mm (2 mm wide margin at one side for wire bonding)

Ladder: support + chips + FPC

0.1mm gap between chips

Ladder of inner layer(16.8 x 134.4 mm)
10 chips total including both sides

Ladder of outer two layers(16.8 x 266.9 mm)
20 chips total including both sides



The designs of the ladder support (ladder-spt)

Size: outer and middle barrels 266.9 x 16.8 x 2 mm (L x W x H).
for inner barrel 134.4 x 16.8 x 2 mm.

Material: CFRP, each surface has a total thickness of 0.15 mm*.

Current preferred design



Two other optional designs:

Both have the same overall dimensions as the preferred design.

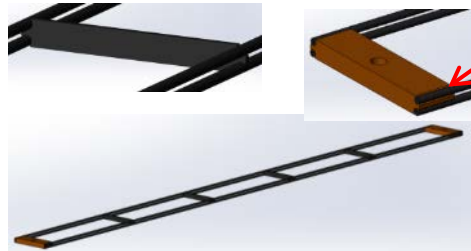
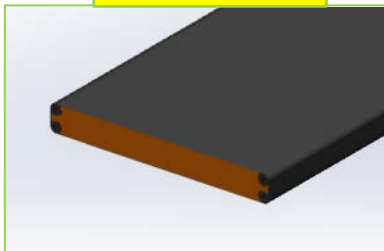
A: 2 bars made of PMI foam inside the support

B: the CFRP pipes (or rod) and surface combination

Option A



Option B-Va



Pipe: OD- 0.8 mm
ID- 0.6 mm

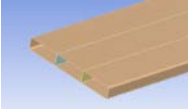
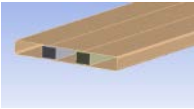

Option B-Vb



Static analysis of the ladder-spt designs

The same boundary condition and the same extra load for each analysis.

The CFRP used in the simulation is less rigid than that we finally will use.

	Design scheme	Mass (g)	Def. Self weight+ load (μm)	Def. under load (μm)
	✓ Preferred design	2.56	4.1	2.14
	✗ Option A	2.55	7.6	
	? Option B	2.11*	2.1	1.3

Option A: with the same mass as the preferred design, the stiffness is smaller.

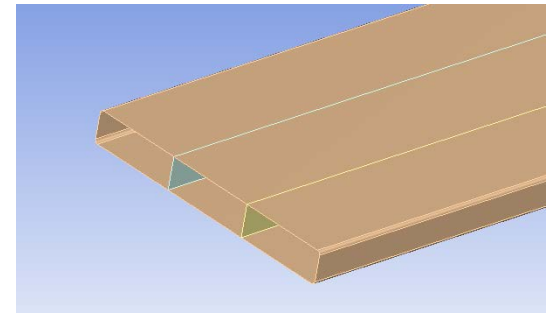
Option B: about 18% material is reduced than the preferred design. Very challenging to make it our size, but still have great potential , fabrication feasibility to be further investigated.

Comparative FEA analysis-1

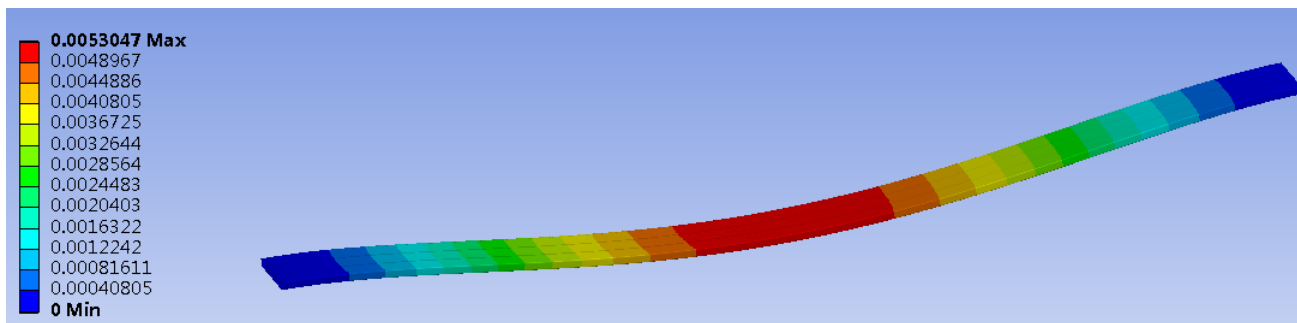
To evaluate the contribution of the sensors and FPCs to the rigidity of the ladder support, two comparative FEA analysis were done based on the current preferred design.

Analysis -1 A bare ladder support with pressure load

- 2.055 g (4.11 g in total) weight of sensors and FPC on either sides of the support, evenly distributed to two side surfaces as pressure load.
- Self weight 2.56 g.



Max def. under full load: 5.3 um



Model of the complete ladder

A complete ladder model with:

- A Ladder support (CFRP)
- FPCs on both sides (kapton + equivalent mass of Aluminum and adhesive)
- Sensors on both sides (50 um silicon)

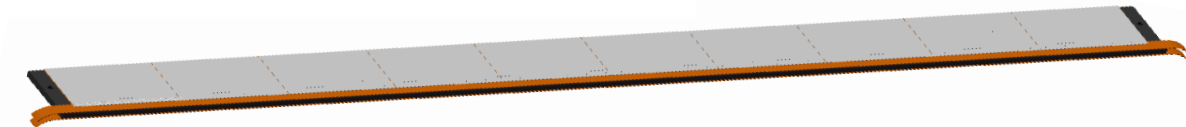
FPC laminates(*)

Mingyi provide

	thickness
Polyimide	25um
Adhesive	28um
Plating copper	17.8um
kapton	50um
Plating copper	17.8um
Adhesive	28um
Polyimide	25um

Polyimide $50+25*2 = 100 \text{ um}$

Al $18*2 = 36 \text{ um}$

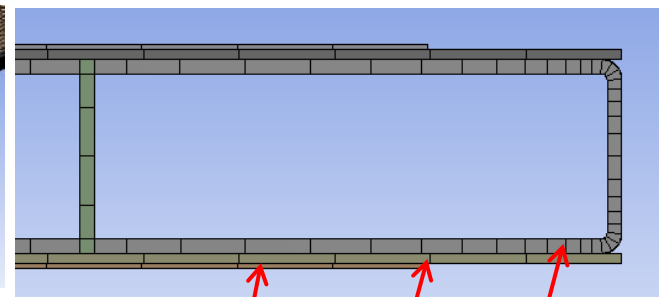
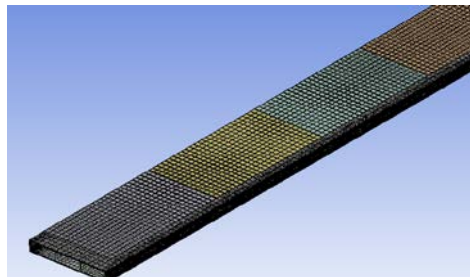
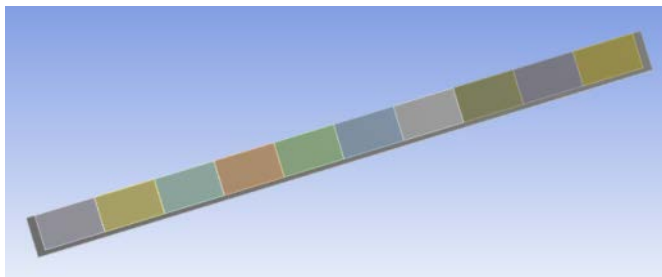


Comparative FEA analysis-2

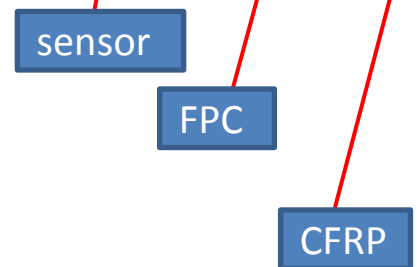
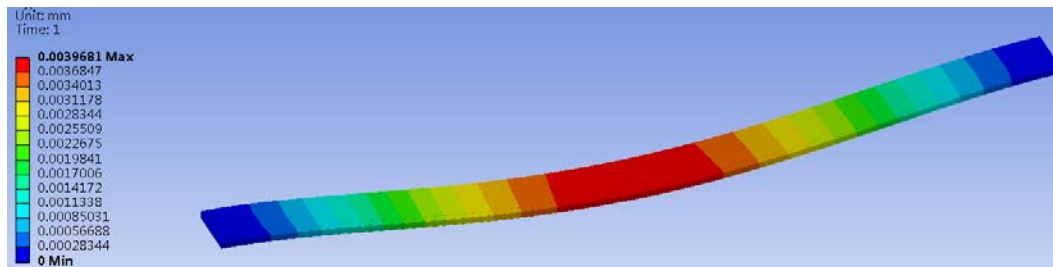
The analysis of a complete ladder model (including the support with sensors and FPCs on both sides):

The total load and the boundary condition are the same as analysis-1.

The adhesive layers between the parts and the interlayers of Aluminum trace of the FPC were not modeled, but the mass of these materials was added to the FPC by increasing the density of it.



Max def: 4 μm

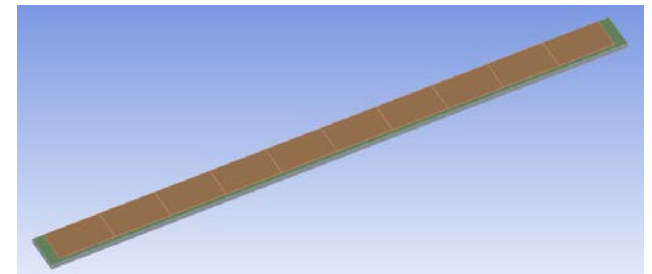
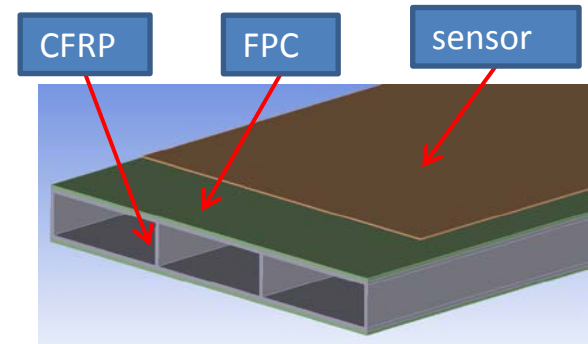


After the FPC with sensors glued on, the rigidity of the full ladder is increased about 20% compare to that of the bare ladder-spt.

Cooling analysis of a complete ladder

A complete ladder model with:

- A Ladder support (CFRP *)
- FPCs on both sides (kapton + Aluminum)
- Sensors on both sides (50 um silicon)
- adhesive not considered
- Contact thermal resistance ignored



FPC laminates

Mingyi provide

	thickness
Polyimide	25um
Adhesive	28um
Plating copper	17.8um
kapton	50um
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Polyimide $50+25*2 = 100 \text{ um}$

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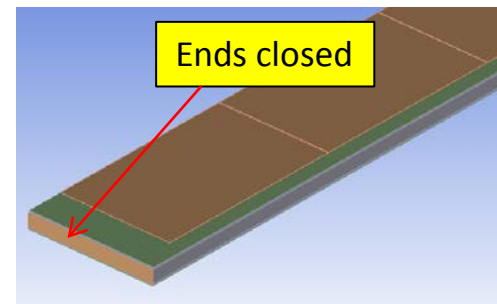
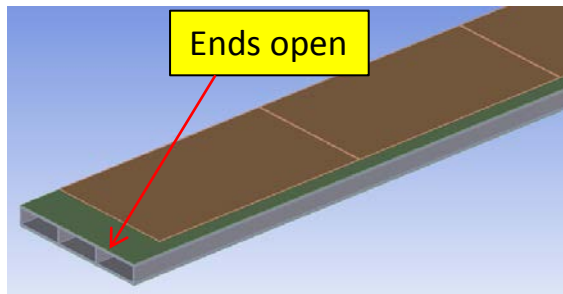
Adhesive is not considered

Results of a complete ladder cooling analysis

ends open VS sealed

Power dissipation (mW/cm ²)	Inlet air temperature (°C)	Inlet air velocity (m/s)	Max temperature (°C) - Ends OPEN	Max temperature (°C) - Ends SEALED
200	20	3	57.1	57.4
200	20	4	50.5	51.3
200	20	5	46.4	47.6

At a speed of 3 m/s, the difference between the ladder with ends open and closed is only 0.3 °C (57.4-57.1).



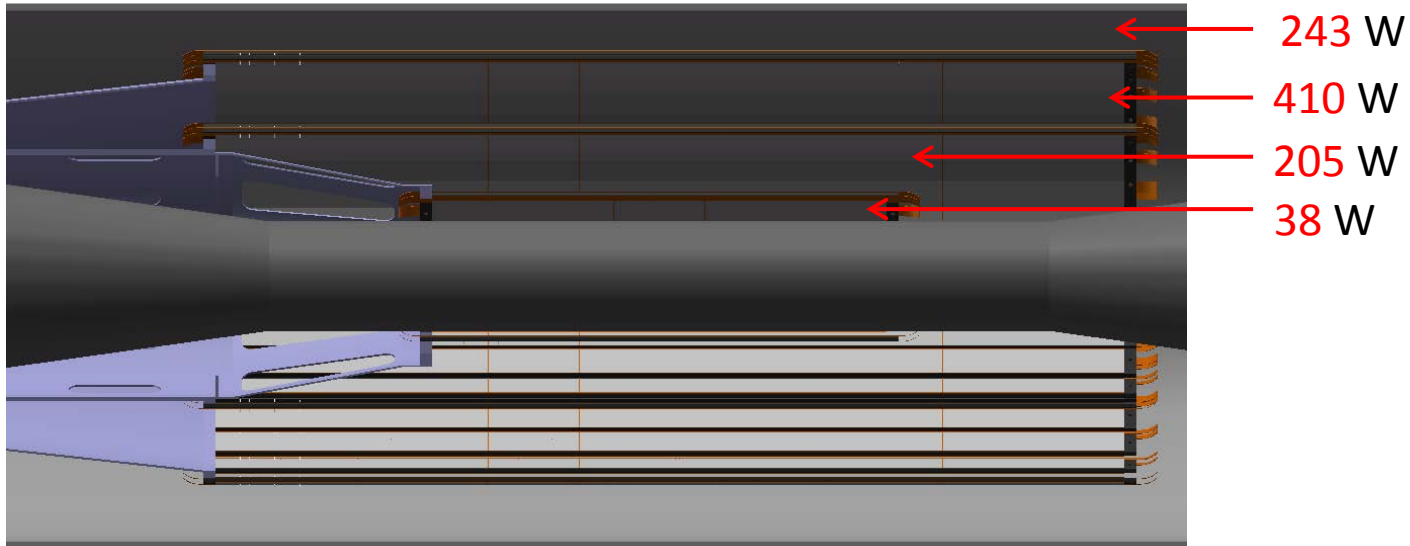
Also the cooling of ladder with sensor which has different local power dissipations has been done.

Heat generation of VXT

Sensor Power dissipation:

Current (short term) goal: $\leq 200 \text{ mW/cm}^2$. (air cooling)

Final goal of CEPC: $\leq 50 \text{ mW/cm}^2$. (air cooling)

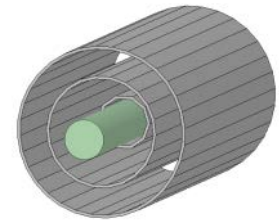


At 200 mW/cm^2 dissipation, the total heat generation is about 900 W , for CEPC level it is about 225 W .

Cooling analysis of the simplified VTX of CEPC

As a first step of the overall cooling simulation, this is a rough simulation to get preliminary estimate of the feasibility of the forced air cooling. Compared with reality, below items are simplified :

- 3 adiabatic barrels* instead of the real support structure with overlapped ladders.
- the total heat generation of each detector layer is evenly smeared on the sides (silicon plate) of the barrel.

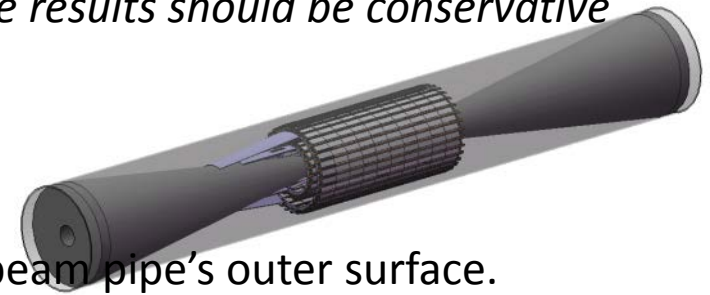


i.g. just sensors and forced cooling air in the cooling box (which is a hollow cylinder with a ID of 150mm to mimic the outer tube of beam pipe).

Due to the properties of this model, generally, the results should be conservative compared with the actual structure.

Also given:

- 0 degree Celsius inlet air temperature.
- 30 degree Celsius constant temperature of beam pipe's outer surface.



The minimum gap (distance) between the inner barrel and beam pipe is:
 $(D_{32.4} - \Phi_{30.7}) / 2 = 0.85$ mm in radius direction.

Power dissipation and velocity of the inlet air vary according to different setup.

Preliminary Results

Power dissipation (mW/cm2)	Temperature of beam pipe's surface (°C)	Inlet air temperature (°C)	Inlet air velocity (m/s)	Max temperature of inner barrel (°C)	Max temperature of middle barrel (°C)	Max temperature of outer barrel (°C)
200	30	0	5	113.1	76.1	73.2
200	30	0	6	106.7	69	66.4
100	30	0	3	79.2	48.5	45.7
100	30	0	4	74.9	42.4	39.8
100	30	0	5	71.2	38	36.6
50	30	0	2	57.1	29.1	26.9
50	30	0	3	54.5	24.3	22.9
50	30	0	4	52.3	21.3	19.9

Note that, the current simplified simulation is **conservative** compare with reality.

Next

- Cooling analysis close to real structure and working condition will be studied:
 - Individual ladders deployed the same as the general structure design.
 - System level analysis by integrating the support structures, end cap disks, inlets and outlets (fan and griller for prototype cooling box).
- *Analysis of vibration amplitude caused by air cooling?*